

04/07/2008

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Connell et al.

**Serial No.:** 10/706,212

**Filed:** November 12, 2003

**For:** WAFER BACK SIDE COATING TO  
BALANCE STRESS FROM PASSIVATION  
LAYER ON FRONT OF WAFER AND BE  
USED AS A DIE ATTACH ADHESIVE

**Confirmation No.:** 6326

**Examiner:** M. Landau

**Group Art Unit:** 2815

**Attorney Docket No.:** 2269-5083.1US  
(2001-0428.01/US)

**VIA ELECTRONIC FILING**  
**March 28, 2008**

**AMENDMENT UNDER 37 C.F.R. § 1.116**

MAIL STOP AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of February 21, 2008 whose initial period of response is set to expire on May 21, 2008.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.